

# SLOVENSKI STANDARD

## SIST EN IEC 62680-1-3:2019

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**Vmesniki univerzalnega serijskega vodila za prenos podatkov in napajanje - 1-3. del: Skupne komponente - Specifikacija za kable in priključke univerzalnega serijskega vodila tipa CTM (IEC 62680-1-3:2018)**

Universal serial bus interfaces for data and power - Part 1-3: Common components - USB Type-CTM Cable and Connector Specification (IEC 62680-1-3:2018)

Schnittstellen des Universellen Seriellen Busses für Daten und Energie - Teil 1-3: Gemeinsame Bauteile - Festlegung für USB-Typ-CTM-Kabel und -Steckverbinder (IEC 62680-1-3:2018)

Interfaces de bus universel en série pour les données et l'alimentation électrique - Partie 1-3: Composants communs - Spécification des câbles et connecteurs USB de type CTM (IEC 62680-1-3:2018)

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- Spécification des câbles et connecteurs USB de type C™  
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Schnittstellen des Universellen Seriellen Busses für Daten  
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# INTERNATIONAL STANDARD



Universal serial bus interfaces for data and power –  
Part 1-3: Common components – USB Type-C™ Cable and Connector  
Specification

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## UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER –

Part 1-3: Common components –  
USB Type-C™ Cable and Connector Specification

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This third edition cancels and replaces the second edition published in 2017 and constitutes a technical revision.

The text of this standard was prepared by the USB Implementers Forum (USB-IF). The structure and editorial rules used in this publication reflect the practice of the organization which submitted it.

The text of this International Standard is based on the following documents:

CDV	Report on voting
100/3011/CDV	100/3099/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

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## INTRODUCTION

The IEC 62680 series is based on a series of specifications that were originally developed by the USB Implementers Forum (USB-IF). These specifications were submitted to the IEC under the auspices of a special agreement between the IEC and the USB-IF.

This standard is the USB-IF publication USB Type-C™ Cable and Connector Specification Revision 1.3 as of July 14, 2017.

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# Universal Serial Bus Type-C Cable and Connector Specification

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